

# AN14458

How to reach LPUART maximum band rate of 24 Mbit/s on MCX A series

Rev. 1.0 — 17 October 2024

Application note

## Document information

Information	Content
Keywords	AN14458, MCX A series, LPUART, 24 Mbit/s, Trim Clock
Abstract	This application note describes how to reach LPUART maximum band rate of 24 Mbit/s on MCX A series and test on FRDM-MCXA153 board.



## 1 Introduction

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The MCX A series microcontrollers powered by the Arm Cortex-M33 are general-purpose MCUs designed to address a wide range of applications with scalable device options, low power, and intelligent peripherals. They offer the Low-Power Universal Asynchronous Receiver/Transmitter (LPUART). It provides an asynchronous serial bus with commander and responder operations. MCXA152/3 supports 3 instances of LPUART and MCXA154/5/6 supports 5 instances of LPUART. Usually, the microcontroller communicates with the host computer through UART and prints debug logs. In this use case, the most common baud rates are 9600 bit/s and 115200 bit/s, it is an easy task for a microcontroller. However, in some use cases, a high baud rate LPUART is needed, and for MCX A series, the maximum baud rate of 24 Mbit/s is supported. This application note introduces the LPUART module in MCX A series and describes how to reach to LPUART maximum baud rate of 24 Mbit/s in detail:

- How to set up the LPUART to get the 24Mbit/s baud rate
- How to implement LPUART send, receive and check
- How to calculate the transmission error data rate
- How to output the FRO\_HF clock
- How to trim the FRO\_HF clock manually
- How to automatically trim the FRO\_HF clock using an external crystal

## 2 LPUART overview

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LPUART provides an asynchronous serial bus with commander and responder operations. It can reach a 24 Mbit/s maximum transfer rate. The data is based on characterization but not covered by the test limits in production.

### 2.1 Features

- Full-duplex, standard NRZ format
- Programmable baud rates (13-bit modulo divider) with a configurable oversampling ratio (OSR) from 4× to 32×, up to 24 Mbit/s.
- Asynchronous operation of transmit and receive baud rates regarding the bus clock:
  - The baud rate can be configured independently of the bus clock frequency.
  - Operation in Low-Power modes is supported.
- Support interrupt, DMA, or polled operations:
  - Transmit data empty and transmission complete
  - Receive data full
  - Receive overrun error, parity error, framing error, and noise error
  - Idle receiver detect
  - Active edge on receive pin
  - Break detect supporting LIN
  - Receive data match
- Hardware parity generation and checking
- Programmable 7-bit, 8-bit, 9-bit, or 10-bit data bits
- Programmable 1-bit or 2-bit stop bits
- Support for three receiver wake-up methods:
  - Idle line wake-up
  - Address mark wake-up

- Receive data match
- Automatic address matching to reduce ISR overhead
  - Address mark matching
  - Idle line address matching
  - Address match start, address match end
- Optional 13-bit and 11-bit break character generation
- Configurable idle length detection supporting 1, 2, 4, 8, 16, 32, 64, or 128 idle characters
- Selectable transmitter output and receiver input polarity
- Hardware flow control support for request to send (RTS) and clear to send (CTS) signals
- Selectable IrDA 1.4 return-to-zero-inverted (RZI) format with a programmable pulse width
- Independent FIFO structure for transmit and receive functions:
  - Separate configurable watermarks for receive and transmit requests
  - An option for the receiver to assert the request after a configurable number of idle characters, if receive FIFO is not empty.

## 2.2 Function

[Figure 1](#) shows the transmitter portion of LPUART and [Figure 2](#) shows the receiver portion of LPUART.

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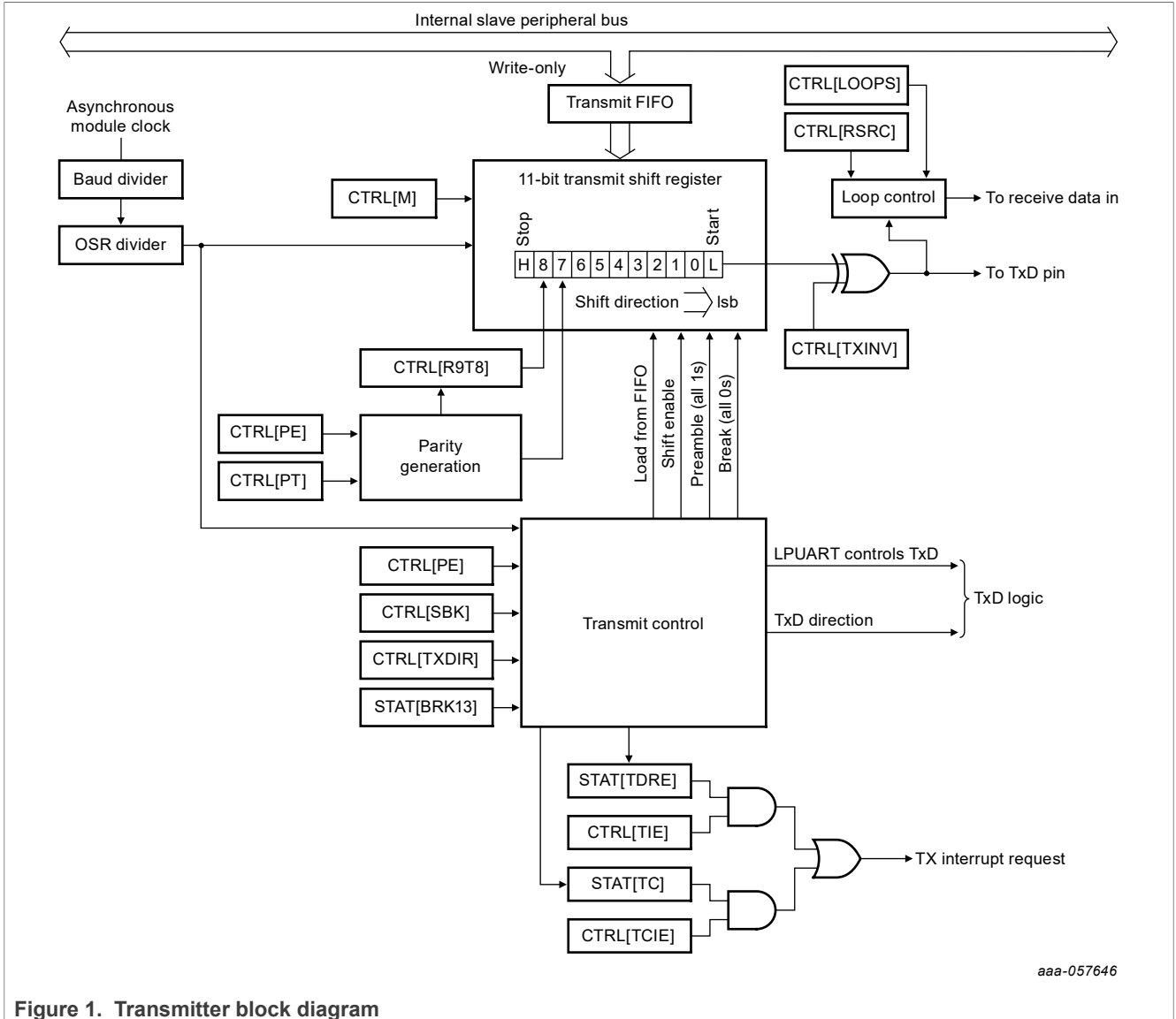


Figure 1. Transmitter block diagram

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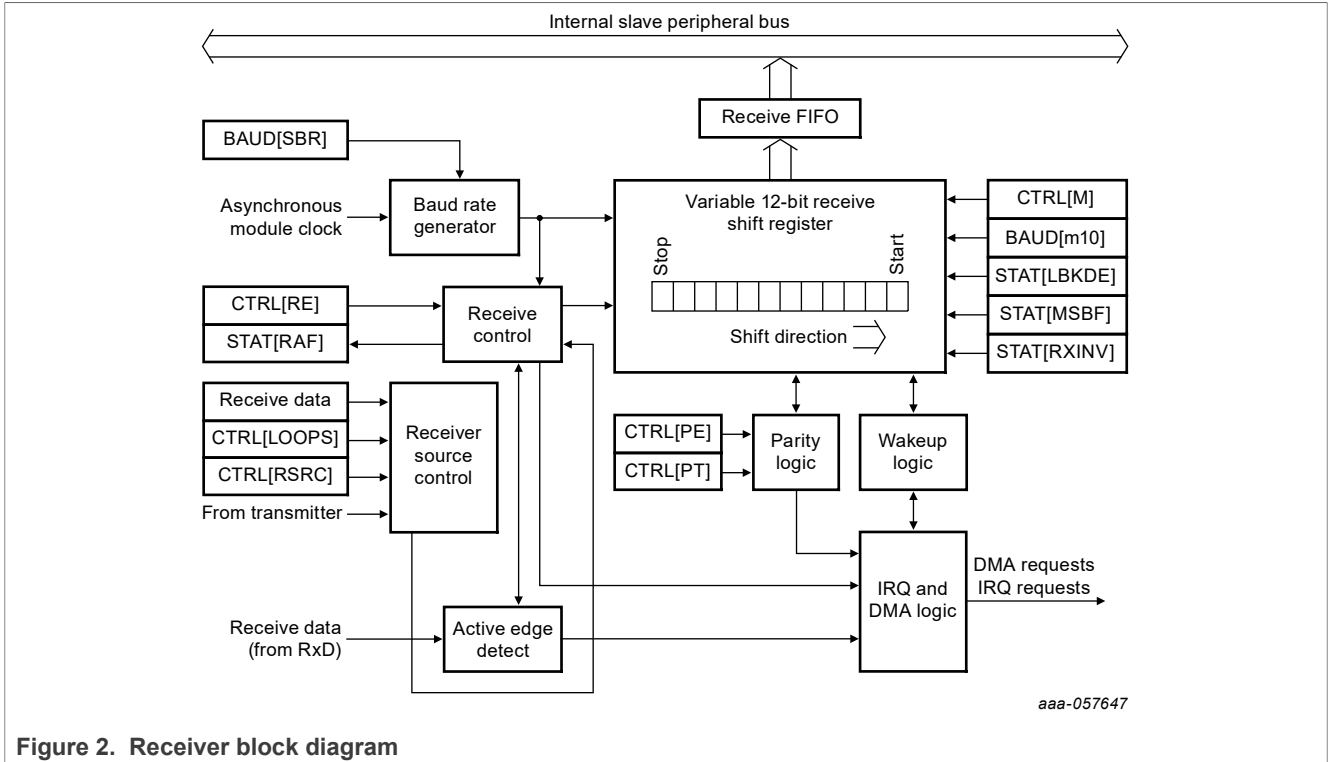


Figure 2. Receiver block diagram

2.2.1 Baud rate generation

A 13-bit modulus counter in the baud rate generator derives the baud rate for both the receiver and transmitter. The value ranging from 1 to 8191 and written to BAUD[SBR] determines the baud clock divisor for the asynchronous LPUART baud clock. The baud rate clock drives the receiver, while a bit clock generated from the baud rate clock divided by the OSR drives the transmitter. Depending on the OSR, the receiver has an acquisition rate of 4 to 32 samples per bit time.

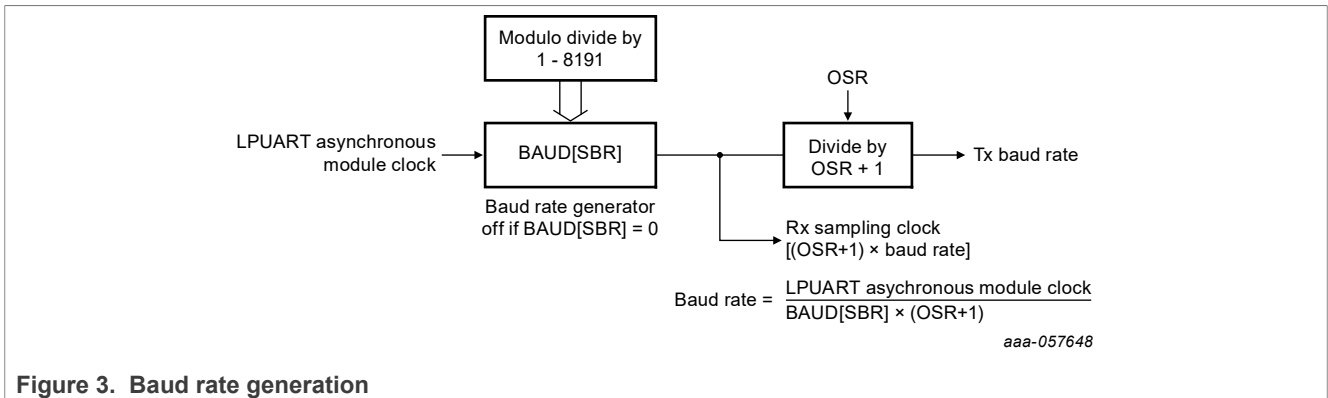


Figure 3. Baud rate generation

To reach the 24 Mbit/s maximum baud rate, set FRO\_HF 96 MHz as the LPUART asynchronous module clock, BAUD[SBR] set to 1, OSR + 1 set to 4, and the baud rate will be 96 MHz / 4 = 24 Mbit/s.

2.2.2 Baud rate tolerance

A transmitting device may operate at a baud rate below or above that of the receiver.

Accumulated bit time misalignment can cause one of the three stop bit data samples to fall outside the actual stop bit. A noise error occurs if the three samples are not all the same logical values. A framing error occurs if the receiver clock is misaligned in such a way that the majority of the three stop bit samples are a logic zero.

As the receiver samples an incoming frame, it may re-synchronize the oversampling clock on any valid falling edge within the frame. Resynchronization within frames corrects a misalignment between transmitter bit times and receiver bit times.

In general, increasing the number of samples per bit increases the baud rate tolerance and decreasing the number of samples per bit reduces the baud rate tolerance.

**Note:** Since LPUART implements triple voting on consecutive receive data samples, increasing the number of samples per bit moves those samples closer together that would reduce the width of noise that can be filtered by the triple voting logic.

### 2.2.3 Calculating baud rate tolerance

Using the following definitions:

- SAM is the number of sample points per bit (valid range from 8 to 32; equal to  $(OSR + 1) \times (BOTHEDGE + 1)$ ).
- BIT is the number of bits in a character including start, data, and stop bits (valid range from 9 to 13).

The ideal baud rate tolerance can be calculated as follows:

- Slow data rate tolerance =  $((SAM \div 2) - 1) \div ((SAM \times BIT) - (SAM \div 2) + 2)$
- Fast data rate tolerance =  $((SAM \div 2) - 2) \div (SAM \times BIT)$

In this example,  $OSR + 1 = 4$ ,  $BOTHEDGE = 1$ ,  $SAM = 4 \times 2 = 8$ ,  $BIT = 10$  (1 start bit, 8-bit data, 1 stop bit):

- Slow data rate tolerance =  $(4 - 1) \div (80 - 4 + 2) = 3 \div 78 = 3.85 \%$
- Fast data rate tolerance =  $(4 - 2) \div 80 = 2 \div 80 = 2.5 \%$

## 3 Software design

The software is based on FRDM-MCXA153 SDK 2.16.0 `driver_examples/lpuart/lpuart_edma_transfer` that is an LPUART transfer example using eDMA. The user must be familiar with this example and the related hardware.

This software uses one FRDM-MCXA153 as the Sender, uses another FRDM-MCXA153 as the Receiver, the Sender sends the data to the Receiver using LPUART @24Mbps baud rate, and then receives the data replied by the Receiver and calculates the error data rate.

### 3.1 Clock generation

To set the LPUART baud rate to 24 Mbit/s, use FRO\_HF 96 MHz as the LPUART asynchronous module clock, and divided it to 24 MHz to reach the 24 Mbit/s LPUART baud rate, refer to [Section 2.2.1](#) for more detail.

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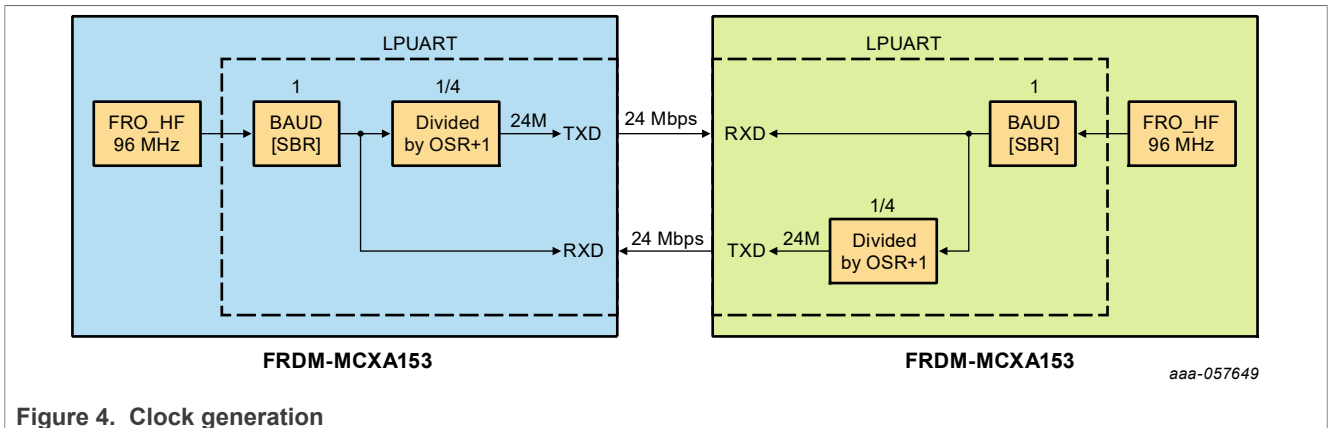


Figure 4. Clock generation

The core code for the clock generation is as follows:

```
CLOCK_SetupFROHFClocking(96000000U); /* !< Enable FRO HF(96MHz) output */
/*!< Set up dividers */
CLOCK_SetClockDiv(kCLOCK_DivFRO_HF_DIV, 1U); /* !< Set FROHFDIV divider to value 1 */

/* attach 96 MHz clock to FLEXCOMM2, use LPUART2 to test the 24Mbps baud rate */
CLOCK_SetClockDiv(kCLOCK_DivLPUART2, 1u);
CLOCK_AttachClk(kFRO_HF_DIV_to_LPUART2);
RESET_PeripheralReset(kLPUART2_RST_SHIFT_RSTn);
```

### 3.2 Transfer process

To verify the reliability of the transmission, the following transfer process is used for test, where one MCXA153 is used as the Sender and another MCXA153 is used as the Receiver.

1. The Sender sends the start signal. The Receiver receives the start signal and records.
2. The Receiver replies to the start signal to the Sender, the Sender checks whether it is correct, if correct, connect success.
3. The Sender starts to send the test data, the Receiver receives them and records.
4. The Receiver replies the test data to the Sender. The Sender checks them and returns to step 3.

**Note:**

1. start signal: 0x12, 0x21; test data: from 0x0000 to 0x07FF total 4096 bytes.
2. The Sender should be reset after the Receiver.
3. Other MCX A series like MCXA156 are also supported and there is no difference. Use MCXA153 as an example.

And the user can understand the whole process more clearly through the figure below:

How to reach LPUART maximum band rate of 24 Mbit/s on MCX A series

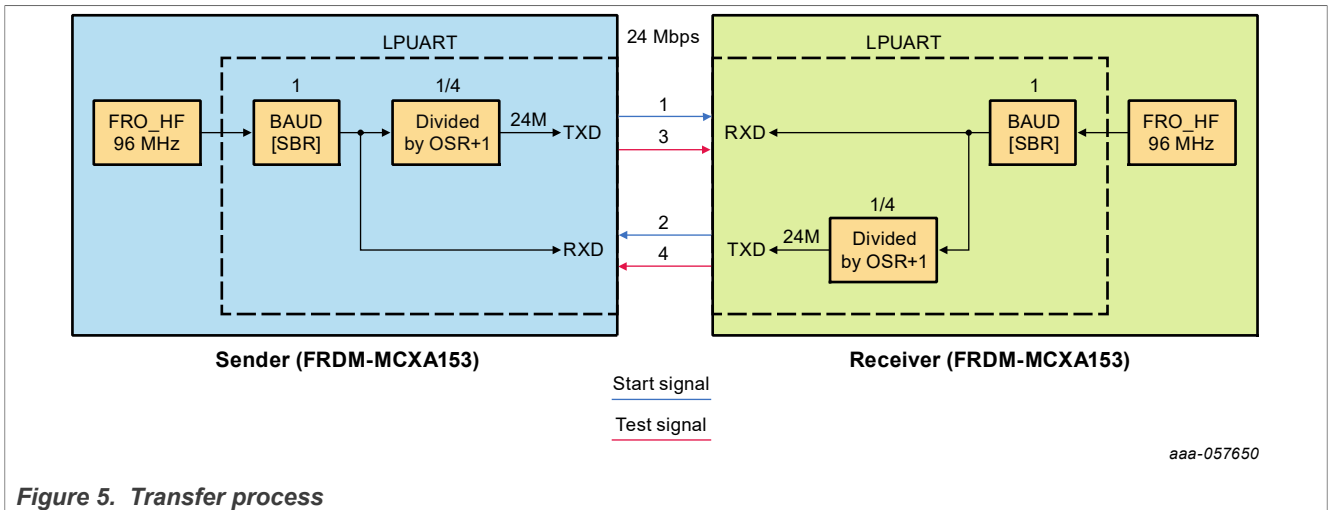


Figure 5. Transfer process

To send/receive the data through LPUART, refer to the below code for reference. The core code for the Sender to send, receive, and check the start signal is as follows:

```
uint8_t g_startBuffer[2] = {0x12, 0x21}; // Start signal
uint8_t g_rxBuffer[2] = {0}; // RX buffer

/* LPUART eDMA handle define */
lpuart_edma_handle_t g_lpuartEdmaHandle;

/* LPUART transfer and receive structure define */
lpuart_transfer_t xfer;
lpuart_transfer_t sendXfer;
lpuart_transfer_t receiveXfer;

/* Send communication start signal */
xfer.data = g_startBuffer;
xfer.dataSize = 2;
txOnGoing = true; // See SDK example for details
LPUART_SendEDMA(LPUART2, &g_lpuartEdmaHandle, &xfer);
PRINTF("FRDM-MCXA153 LPUART_24Mbps Demo, this is the sender\r\n");
PRINTF("Sending the communication start signal...\r\n");

/* Wait send finished */
while (txOnGoing) // See SDK example for details
{
}
PRINTF("Send Done\r\n");

PRINTF("Receiving the communication start signal...\r\n");
/* Receive communication start signal */
receiveXfer.data = g_rxBuffer;
receiveXfer.dataSize = 2;
rxOnGoing = true;
LPUART_ReceiveEDMA(LPUART2, &g_lpuartEdmaHandle, &receiveXfer);
while (rxOnGoing) // See SDK example for details
{
}
PRINTF("Receive Done\r\n");

PRINTF("Received the connect success signal\r\n");
if ((receiveXfer.data[0] == g_startBuffer[0]) && (receiveXfer.data[1] ==
g_startBuffer[1]))
{
connectSuccess = true;
PRINTF("Connect Success\r\n");
}
}
```



```
else
{
    PRINTF("Connect Fail\r\n");
}
```

The core code for the Sender to send, receive, and check the test data is as follows:

```
uint16_t g_txBuffer16[2048] = {0}; // Send test data
uint16_t g_rxBuffer16[2048] = {0}; // Receive test data

/* Set values for the test data */
for(uint16_t i = 0; i < 2048U; i++)
{
    g_txBuffer16[i] = i;
}

PRINTF("Start to do test...\r\n");
sendXfer.txData16 = g_txBuffer16;
sendXfer.dataSize = 2048U * 2;
receiveXfer.rxData16 = g_rxBuffer16;
receiveXfer.dataSize = 2048U * 2;

while (1)
{
    if(connectSuccess == true && uartCheckDone == false)
    {
        txOnGoing = true; // See SDK example for details
        LPUART_SendEDMA(LPUART2, &g_lpuartEdmaHandle, &sendXfer);
        /* Wait send finished */
        while (txOnGoing) // See SDK example for details
        {
        }
        PRINTF("Send Done\r\n");

        rxBufferEmpty = true; // See SDK example for details
        rxOnGoing = true; // See SDK example for details
        LPUART_ReceiveEDMA(LPUART2, &g_lpuartEdmaHandle, &receiveXfer);
        while(rxOnGoing) // See SDK example for details
        {
        }
        PRINTF("Receive Done\r\n");

        UART_Check(); // Count Transfer number and Error data number, see section 3.3
    }
}
```

The core code for the Receiver to receive, check, and reply the start signal is as follows:

```
uint8_t g_startBuffer[2] = {0x12, 0x21}; // Start signal
uint8_t g_rxBuffer[2] = {0}; // RX buffer

/* LPUART eDMA handle define */
lpuart_edma_handle_t g_lpuartEdmaHandle;

/* LPUART transfer and receive structure define */
lpuart_transfer_t xfer;
lpuart_transfer_t receiveXfer;

PRINTF("FRDM-MCXA153 LPUART 24Mbps Demo, this is the Receiver\r\n");
PRINTF("Receiving the communication start signal...\r\n");
/* Receive communication start signal */
receiveXfer.data = g_rxBuffer;
receiveXfer.dataSize = 2;
rxOnGoing = true; // See SDK example for details
LPUART_ReceiveEDMA(LPUART2, &g_lpuartEdmaHandle, &receiveXfer);
```

```

while(rxOnGoing)    // Wait for start signal
{
}
PRINTF("Receive Done\r\n");

if((receiveXfer.data[0] == g_startBuffer[0]) && (receiveXfer.data[1] ==
g_startBuffer[1]))
{
    PRINTF("Connect Success\r\n");
    connectSuccess = true;    // Global variable to indicate connect success
    rxBufferEmpty    = true; // See SDK example for details
    /* Reply communication start signal */
    xfer.data        = g_startBuffer;
    xfer.dataSize = 2;
    txOnGoing      = true;    // See SDK example for details
    LPUART_SendEDMA(LPUART2, &g_lpuartEdmaHandle, &xfer);
    PRINTF("Sending the connect success signal...\r\n");
    /* Wait send finished */
    while (txOnGoing)    // See SDK example for details
    {
    }
    PRINTF("Send done\r\n");
}
else
{
    PRINTF("Connect Fail\r\n");
}
}

```

The core code for the Receiver to receive and reply the test data is as follows:

```

uint16_t g_txBuffer16[2048] = {0}; // Send test data
uint16_t g_rxBuffer16[2048] = {0}; // Receive test data

PRINTF("Start to do test...\r\n");
sendXfer.txData16    = g_txBuffer16;
sendXfer.dataSize    = 2048U * 2;
receiveXfer.rxData16 = g_rxBuffer16;
receiveXfer.dataSize = 2048U * 2;

while (1)
{
    if(connectSuccess == true) // Sender and Receiver connect success
    {
        rxBufferEmpty = true; // See SDK example for details
        rxOnGoing = true; // See SDK example for details
        LPUART_ReceiveEDMA(LPUART2, &g_lpuartEdmaHandle, &receiveXfer);
        while(rxOnGoing) // See SDK example for details
        {
        }
        PRINTF("Receive Done\r\n");

        memcpy(g_txBuffer16, g_rxBuffer16, BUFFER_LENGTH * 2);
        memset(g_rxBuffer16, 0, BUFFER_LENGTH * 2);

        txOnGoing = true; // See SDK example for details
        LPUART_SendEDMA(LPUART2, &g_lpuartEdmaHandle, &sendXfer);
        /* Wait send finished */
        while (txOnGoing) // See SDK example for details
        {
        }
        PRINTF("Reply Done\r\n");
    }
}
}

```

### 3.3 Error data rate calculate

To check the error data rate, follow the steps below:

1. Count the transfer number.
2. Compare the test data sent by the Sender and the test data reply by the Receiver.
3. Find the mismatch data and count the error data number.
4. Calculate the error data rate using the transfer number and the error data number. The core code for the error data rate calculate is as follows:

```
/**
 * @brief    UART_Check    UART print the transfer number and error data number
 * @param    NULL
 * @return   NULL
 */
void UART_Check()
{
    static uint32_t transferNum = 0;
    static uint32_t errorDataNum = 0;
    float errorDataRate = 0;

    transferNum++;           // transfer number +1 every time

    if (transferNum >= 1000)
    {
        uartCheckDone = true; // Stop the transfer after transfer number reach 1000
    }
    for(uint16_t i = 0; i < BUFFER_LENGTH; i++) // Check whether the data is correct
    {
        if(g_rxBuffer16[i] != g_txBuffer16[i])
        {
            errorDataNum++; // If not match, error data number +1
        }
    }
    errorDataRate = 1.0f * errorDataNum / transferNum; // Calculate the error data rate
    PRINTF("Transfer Num:%u Error Data Num:%u Error Data Rate:%f\r\n", transferNum,
    errorDataNum, errorDataRate);
}
```

### 3.4 Clock out

The user can use the clock output pin to output the clock signal and observe it. In this application note, P3\_8 is used to output the clock signal. Use an oscilloscope or other device to capture the signal and calculate the clock error.

**Note:** First, configure the P3\_8 for the clock out function.

The core code for clock out is as follows, a signal of about 96 MHz is captured after this setting:

```
/**
 * @brief    app_ClockOut    Clock out setting, to observe clock signal
 * @param    NULL
 * @return   NULL
 */
void app_ClockOut()
{
    // Allow clock update
    SYSCON -> CLKUNLOCK = SYSCON_CLKUNLOCK_UNLOCK(0);
    // Choose FRO_HF_DIV as the source
    MRCC0 -> MRCC_CLKOUT_CLKSEL = MRCC_MRCC_CLKOUT_CLKSEL_MUX(1);
    // Direct output
    MRCC0 -> MRCC_CLKOUT_CLKDIV = MRCC_MRCC_CLKOUT_CLKDIV_DIV(0);
    // Freezes clock update
}
```

```

SYSCON -> CLKUNLOCK           |= SYSCON_CLKUNLOCK_UNLOCK(1);
}

```

### 3.5 Trim the FRO\_HF manually

In the MCX A series, the FRO\_HF(FIRC) supports the trim function. It means the user can manually trim the clock to make it closer to the frequency needed. In this way, the user can simulate the effect of temperature and other factors on the clock. The trim register includes the coarse trim and fine trim function. For the coarse trim, the frequency change rate near the center is about 2.5% per bit. For the fine trim, the frequency change rate near the center is about 0.06% per bit. The core code for manual trim FRO\_HF is as follows:

```

/**
 * @brief      app_FircTrim      Manual Trim FRO_HF clock
 * @param      type              TRIM_COARSE 2.5%, TRIM_FINE 0.06%
 *              value            FIRCTRIM + value * 2.5%(TRIM_COARSE) or 0.06%(TRIM_FINE)
 * @return     NULL
 */
void app_FircTrim(trim_type type, char value)
{
    uint32_t trim_value = SCG0 -> FIRCTRIM; // Record the initial trim value
    uint8_t trim_coarse = (uint8_t)(trim_value >> 8);
    uint8_t trim_fine = (uint8_t)trim_value;
    PRINTF("%x\r\n", trim_value);
    /* UNLOCK the trim */
    SCG0 -> TRIM_LOCK = (SCG_TRIM_LOCK_TRIM_LOCK_KEY(0x5A5A)) |
(SCG_TRIM_LOCK_TRIM_UNLOCK(1));
    if (type == TRIM_COARSE) // Coarse trim mode, use coarse trim register
    {
        trim_coarse = trim_coarse + value;
        /* Change the trim register */
        SCG0 -> FIRCTRIM = (trim_value & 0xFFFF0000) | (trim_fine & 0xff) | ((trim_coarse &
0x3f) << 8);
    }
    else if (type == TRIM_FINE) // Fine trim mode, use fine trim register
    {
        trim_fine = trim_fine + value;
        /* Change the trim register */
        SCG0 -> FIRCTRIM = (trim_value & 0xFFFF0000) | (trim_fine & 0xff) | ((trim_coarse &
0x3f) << 8);
    }
    trim_value = SCG0 -> FIRCTRIM;
    PRINTF("%x\r\n", trim_value); // Print the trim value
}

```

### 3.6 Doing autotrimming using the external crystal

If a more accurate clock is needed, the autotrimming using an external crystal is supported. After doing the autotrimming, the accuracy of FRO\_HF can achieve  $\pm 0.25\%$  ( $-40\sim 125\text{ }^{\circ}\text{C}$ ), while without autotrimming the accuracy is  $\pm 3\%$  ( $-40\sim 125\text{ }^{\circ}\text{C}$ ).

**Note:** External crystal is needed here. In this example, an 8 MHz external crystal is connected to the MCU.

The core code for autotrimming is as follows:

```

/**
 * @brief      app_AutoTrim      Run Auto-trimming to trim the clock using external crystal
 * @param      NULL
 * @return     NULL
 */
void app_AutoTrim()
{
    CLOCK_SetupExtClocking(8000000U); // Enable the 8 MHz external crystal
}

```

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```

SCG0 -> FIRCTCFG |= SCG_FIRCTCFG_TRIMSRC(2); // Select the external crystal(SOSC) as
the source
SCG0 -> FIRCTCFG |= SCG_FIRCTCFG_TRIMDIV(7); // Divide the SOSC to 1 MHz
SCG0 -> FIRCCSR &= ~SCG_FIRCCSR_LK(1); // Unlock the FIRCCSR register
SCG0 -> FIRCCSR |= SCG_FIRCCSR_FIRCTREN(1); // Enable auto trim
SCG0 -> FIRCCSR |= SCG_FIRCCSR_FIRCTRUP(1); // Enable update
/* Until it returns 1, indicating FIRC is valid */
while(!(SCG0 -> FIRCCSR & SCG_FIRCCSR_FIRCVLD_MASK));
/* Until it returns 0, indicating no error */
while(SCG0 -> FIRCCSR & SCG_FIRCCSR_FIRCERR_MASK);
/* Until it returns 1, indicating FIRC auto trim locked to target frequency range */
while(!(SCG0 -> FIRCCSR & SCG_FIRCCSR_TRIM_LOCK_MASK));
SCG0 -> FIRCCSR |= SCG_FIRCCSR_LK(1); // Lock the FIRCCSR register
}
    
```

### 4 Test on board

To test the LPUART functions, the FRDM-MCXA153 board is used, as shown in [Figure 6](#).

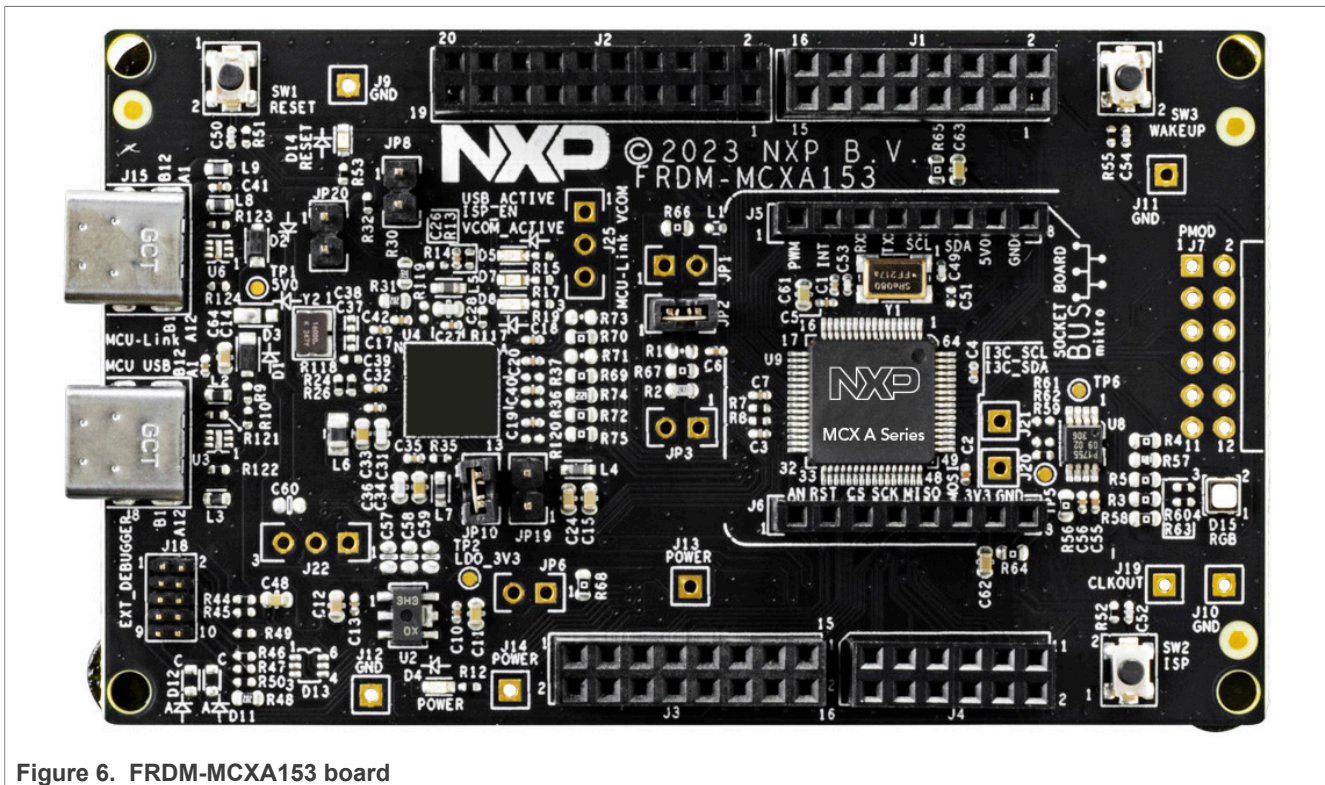


Figure 6. FRDM-MCXA153 board

#### 4.1 Board connection

The FDRM-MCXA153 board ships with an onboard debugger. Use a USB-C cable to connect the board to the computer via J15 for downloading and debugging. In this test, 2x FRDM-MCXA153 boards are needed. The connection is shown below. The board connection is shown in [Figure 7](#).

- LPUART2\_RXD (J1-2) ----- LPUART2\_TXD (J1-4)
- LPUART2\_TXD (J1-4) ----- LPUART2\_RXD (J1-2)
- 5 V (J5-7) ----- 5 V (J5-7)
- GND (J5-8) ----- GND (J5-8)

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**Note:** The Sender must be reset after the Receiver is in the test.

In case the two boards are powered independently, the 5 V connection is not needed.

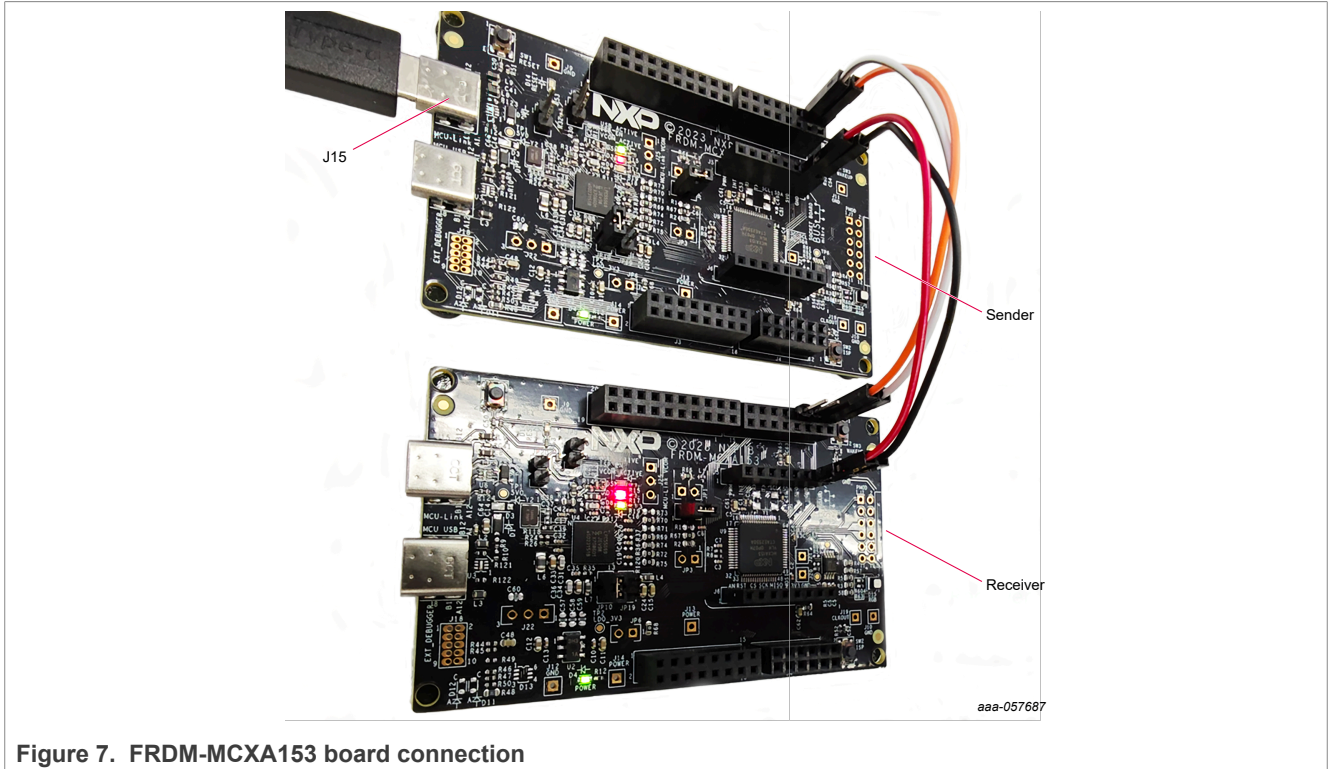


Figure 7. FRDM-MCXA153 board connection

### 4.2 UART debug terminal setup

To observe debug messages from the board, open a UART debug terminal. Set the terminal program to the appropriate COM port and use the setting "115200, 8, none, 1, none", as shown in [Figure 8](#).

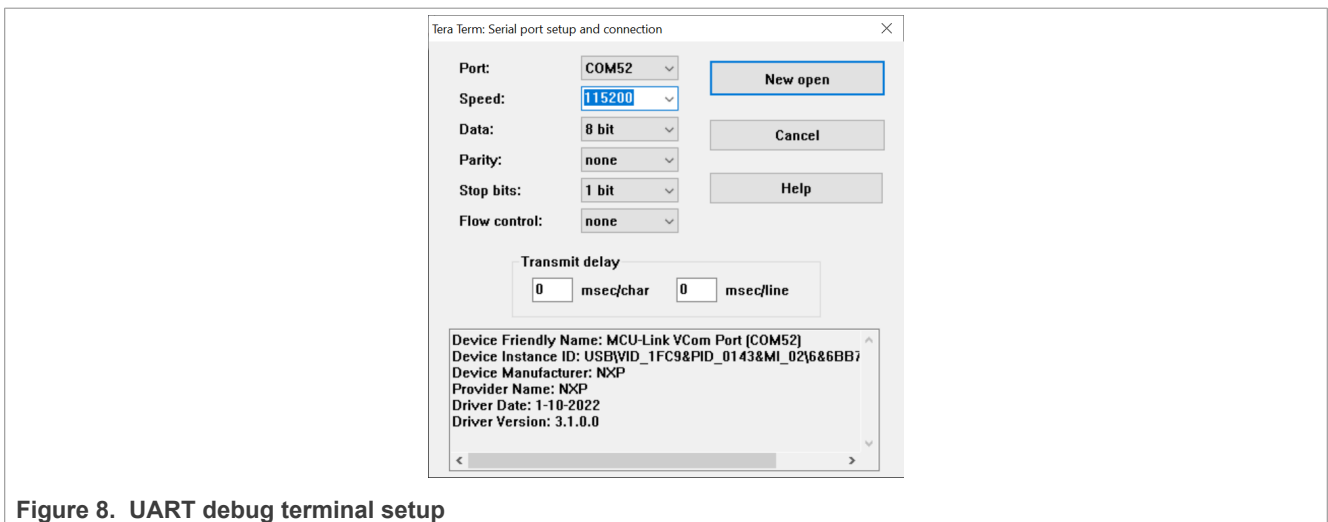


Figure 8. UART debug terminal setup

### 4.3 Test result

Press the RESET button on Receiver and Sender successively and the 24 Mbit/s LPUART communication will begin. The test results are printed to the UART debug terminal. The test result is shown in [Figure 9](#). The Sender and Receiver finished 1000 cycles of test data transmission, and no error data was found.

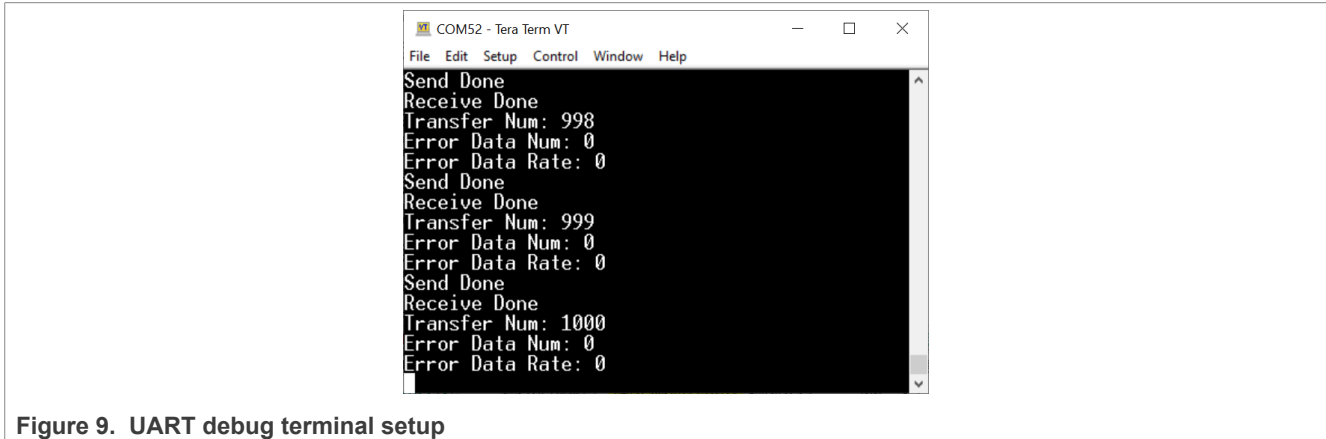


Figure 9. UART debug terminal setup

## 5 Conclusion

This application note provides information and code to help user reach LPUART maximum baud rate of 24 Mbps on MCX A series. The result shows that the communication is reliable.

## 6 Revision history

Table 1. Revision history

Document ID	Release date	Description
AN14458 v.1.0	17 October 2024	Initial version

## 7 Note about the source code in the document

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